

NavChip™ Series 3 *Precision 6-Axis MEMS Inertial Measurement Unit*



GENERAL DESCRIPTION

The NavChip™ Series 3 is a high precision MEMS 6-axis inertial measurement unit (IMU). Using proprietary MEMS technologies and advanced signal processing techniques, the NavChip achieves a level of performance, miniaturization, and environmental ruggedness superior to other IMUs of its size.

The NavChip is especially well-suited for embedded applications where small size, low cost, and low power consumption are required. It is fully factory-calibrated and temperature compensated over an operating range of -40°C to +85°C.

APPLICATIONS

- Augmented and Virtual Reality
- Unmanned Systems
- Robotics
- Camera & Antenna Stabilization
- Pedestrian Navigation
- GPS/INS Integration
- Aiming & Alignment

FEATURES

- Fully-compensated $\Delta\Theta$ and ΔV outputs
- Gyro bias in-run stability 4°/hr
- Angular random walk 0.18°/√hr
- Accel bias in-run stability 0.006 mg
- Velocity random walk 0.02m/s/√hr
- Full-scale angular rate of 2000°/s
- Full-scale acceleration of $\pm 16g$
- Low power consumption 135mW
- Selectable built-in test (BIT) modes for commanded and continuous diagnostic monitoring
- Factory calibrated bias, scale factor and misalignment (-40°C to +85°C)
- TTL UART or SPI data output interfaces
- Embedded temperature sensors
- Selectable output data types and rates (up to 1000 Hz)
- Selectable AHRS output
- External sync pin can accept optional GPS pulse-per-second or faster synchronization signal
- Single supply operation 3.25V to 5.5V
- Small 12.5 x 24.5 x 6.1 mm
- Lightweight 3 g
- Evaluation kits & adapter boards available

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Electrical & Mechanical Specifications

ABSOLUTE MAXIMUM RATINGS

PARAMETER	MIN	MAX	UNITS
VDD to GND	-0.3	+6.0	V
Digital Inputs/Outputs to GND	-0.3	+3.3	V
Analog Inputs to GND	-0.3	+3.3	V
Operating Temperature Range	-40	+85	°C
Storage Temperature Range	-40	+85	°C

Stresses beyond those listed under “Absolute Maximum Ratings” may cause permanent damage to the device. Functional operation of the device at these or any other conditions beyond those indicated in the operational section of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

ESD CAUTION



ESD (electrostatic discharge) sensitive device. Charged devices and circuit boards can discharge without detection. Although this product features patented or proprietary protection circuitry, damage may occur on devices subjected to high energy ESD. Therefore, proper ESD precautions should be taken to avoid performance degradation or loss of functionality.

GYROSCOPE PERFORMANCE (3.3V, +25°C, unless otherwise specified)

PARAMETER	TYP ¹	MAX ²	UNITS
Full Scale Range	± 2000		°/s
In-Run Bias Stability (Allan Variance), Class A	4	5	°/hr
In-Run Bias Stability (Allan Variance), Class B	5	10	°/hr
Bias Accuracy over Operating Temp Range, Class A	± 0.2	± 0.3	°/s
Bias Accuracy over Operating Temp Range, Class B	± 0.2	± 0.4	°/s
g Sensitive Bias	0.004	0.03	°/s/g
Scale Factor Accuracy over Operating Temp Range	± 0.05	± 0.4	%
Scale Factor Linearity ³	0.01	0.05	%
Angle Random Walk	0.18	0.3	°/√hr
Axis Mutual Alignment Accuracy	± 0.03	± 0.2	degrees

ACCELEROMETER PERFORMANCE (3.3V, +25°C, unless otherwise specified)

PARAMETER	TYP	MAX	UNITS
Full Scale Range	± 16		g
In-Run Bias Stability (Allan Variance), Class A	0.006	0.01	mg
In-Run Bias Stability (Allan Variance), Class B	0.04	0.1	mg
Bias Accuracy over Operating Temp Range	± 3	± 15	mg
Scale Factor Accuracy over Operating Temp Range	± 0.09	± 0.2	%
Scale Factor Linearity ⁴	0.06	0.2	%
Velocity Random Walk, Class A	0.02	0.02	m/s/√hr
Velocity Random Walk, Class B	0.03	0.05	m/s/√hr
Axis Mutual Alignment Accuracy	± 0.03	± 0.2	degrees

¹ TYP Specs are mean values or 1σ for values that are nominally zero.

² MAX Specs are maximum factory test limits unless otherwise specified.

³ Factory test up to 810 °/s

⁴ Factory test over ± 1g

DIGITAL INPUTS/OUTPUTS

PARAMETER	MIN	TYP	MAX	UNITS
Logic "0" Input Voltage	0		0.6	V
Logic "1" Input Voltage	2.1		3	V
Logic "0" Output Voltage		0	0.4	V
Logic "1" Output Voltage	2.4	3		V
Logic "0" Input Current		± 2		μA
Logic "1" Input Current		± 2		μA
Input Capacitance		10		pF

TEMPERATURE SENSOR PERFORMANCE

PARAMETER	MIN	TYP	MAX	UNITS
Temperature Sensing Range	-40		+85	°C
Resolution		0.05		°C
Accuracy		± 2.5	± 3.5	°C
Repeatability		± 0.5		°C

FLASH MEMORY

PARAMETER	Nominal	UNITS
Endurance	10,000	Cycles
Data Retention	20	Years

TIMING

PARAMETER	Nominal	UNITS
Power-on Startup (including 0.5s bootloader timeout)	< 1.0	Seconds
Built In Test Time (commanded TBIT)	< 2.0	Seconds

PHYSICAL

PARAMETER	Nominal	UNITS
Size (W x L x H, including interconnect stack height)	12.5 x 24.5 x 6.1	mm
Weight	3	grams
RoHS Compliant	Yes	-

ELECTRICAL

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Supply Voltage Range	Vdd		3.25	3.3	5.5	V
Supply Current	Idd	after startup		40		mA
Internal power supply decoupling capacitance				200		μF

UART INTERFACE

PARAMETER	MIN	TYP	MAX	UNITS
Baud rate	38,400	115,200	921,600	Bits per second
Baud rate deviation from nominal	-1.5	± 0.2	1.5	%
8 data bits, 1 start bit, no parity				

Functional Description

The NavChip is a miniature precision IMU that outputs compensated $\Delta\Theta$ and ΔV data and is factory calibrated over a -40°C to $+85^{\circ}\text{C}$ temperature range.

The NavChip implements both UART and SPI communication interfaces. The UART interface is capable of operating at baud rates ranging from 38400 baud to 921600 baud. Both interfaces support user-selectable data output rates up to 1000 Hz. The NavChip communication protocol is packet-based and enables the user to configure the device, receive data, and monitor the device's status. See the NavChip Interface Control Document (ICD) for details on the operation of these interfaces.

Figure 1 depicts the NavChip's internal processing. The NavChip performs data acquisition and processing at a precise 1000 Hz rate. Compensation is performed to correct the sensors' biases, scale factors, misalignments, etc. Data is output at 200 Hz (5 msec period) by default, but a user may change the output period to select other rates as described in the ICD.

The NavChip's internal sampling may optionally be synchronized to a precision external clock reference such as a GPS pulse-per-second (PPS) signal. Any periodic signal whose period is an integer number of milliseconds between 1 and 1000 can be used for synchronization. Refer to the ICD for timing requirements and details on how to configure NavChip for external synchronization.

Factory calibration corrects for misalignments between the sensor axes resulting in highly orthogonal measurement axes. Alignment of these IMU "intrinsic" axes relative to a host platform (such as a robot, UAV, or camera) will be affected by the precision of the mounting of the NavChip onto the mating board as well as the mounting of the mating board in the host platform.

NavChip provides registers for programming a boresight matrix which rotates the $\Delta\Theta$ and ΔV vectors from the NavChip's internal (intrinsic) reference frame to the vehicle's body frame. This allows customers to compensate for "extrinsic" misalignment angles (the rotation between the intrinsic axes and the host platform). An extrinsic calibration tool is available which will allow the user to determine the boresight matrix relative to a reference jig having two orthogonal surfaces and load it into the NavChip.

The acceleration measurements are computed relative to a coordinate origin point at 1.5mm below the center of the bottom surface of NavChip (i.e. the center of the NavChip footprint on the mating board).

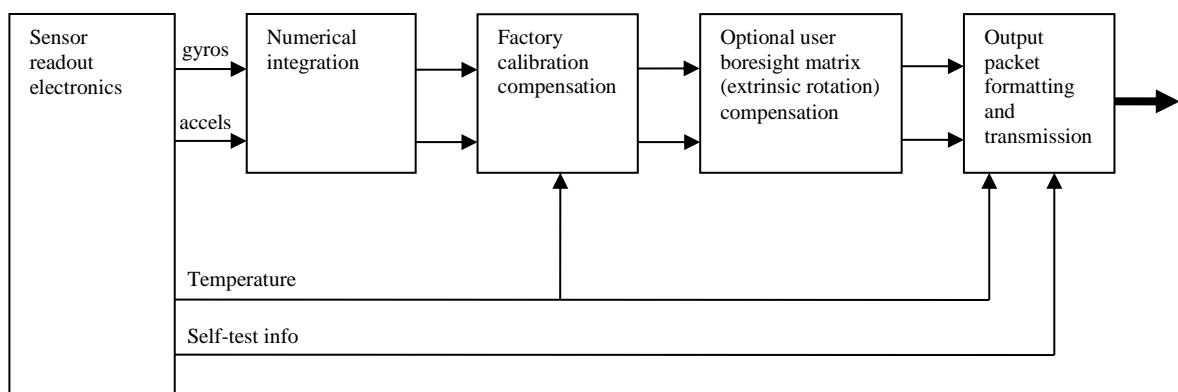


Figure 1: Functional block diagram

Mechanical Renderings

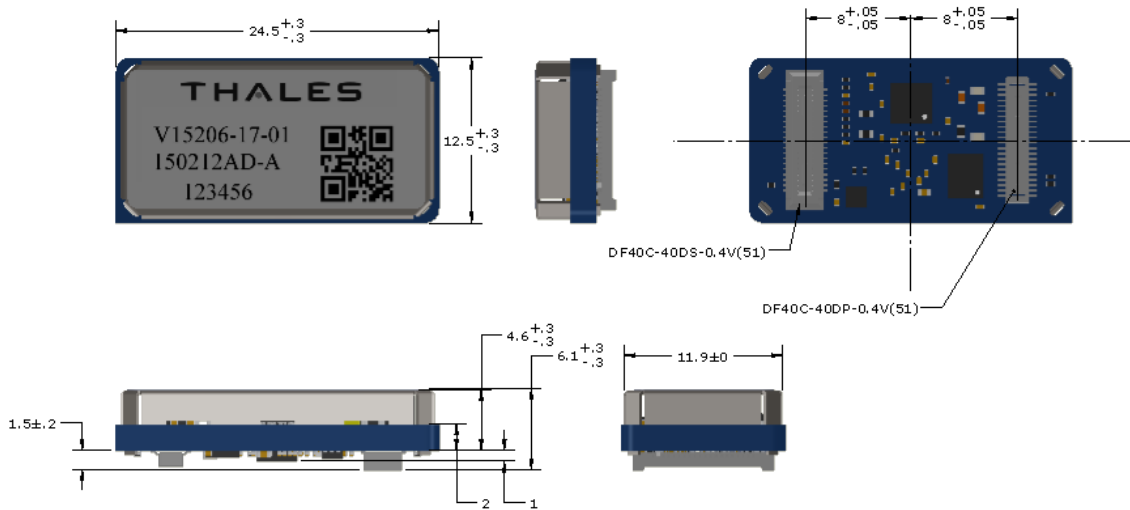


Figure 2: Dimensions (mm)

Mechanical Interface Description

The NavChip has two high density and high contact reliability interface connectors that allow users to design the device directly into their system. The two connectors – designated “P1” and “J1” – have different genders to avoid mis-assembly when plugging the NavChip in.

Connector “J1” is a 40-pin interconnect that is used only to supply ground to the NavChip’s RF shield and secure mounting of the NavChip.

Connector “P1” is a 40-pin interconnect that carries all other electrical interfaces between the NavChip and the user’s board. Please note that P1 actually has 44 pins; the outermost 4 pins are used for structural support only and do not carry any signals. Refer to Figure 3 below for more information regarding pin numbering.

IMPORTANT: DO NOT CONNECT ANY SIGNALS TO THE NC PINS. DOING SO MAY DAMAGE THE NAVCHIP OR CAUSE IT TO MALFUNCTION.

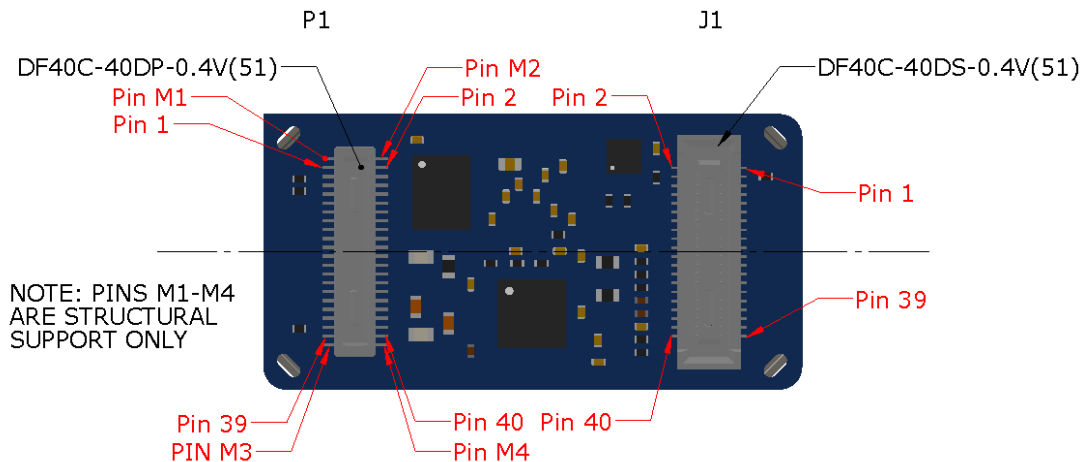


Figure 3: J1/P1 Connector

Table 1: J1 Pin Functional Descriptions

PIN	PIN NAME	PIN TYPE	PIN DESCRIPTION
1	GND	Ground	Power Ground
2	GND	Ground	Power Ground
3-38	NC	-	Reserved for Factory Use
39	GND	Ground	Power Ground
40	GND	Ground	Power Ground

Table 2: P1 Pin Functional Descriptions

PIN	PIN NAME	PIN TYPE	PIN DESCRIPTION
1	Vlogic	Output	3V logic reference output (25mA max.)
2	Vlogic	Output	3V logic reference output
3-8	NC	-	Reserved for Factory Use
9-10	GND	Ground	Ground
11	SPI_SCK	Input	SPI CLK
12	SPI_SCK	Input	SPI CLK
13	SPI_SDO	Output	MISO
14	SPI_SDO	Output	MISO
15	SPI_SDI	Input	MOSI
16	SPI_SDI	Input	MOSI
17-21	NC	-	Reserved for Factory Use
22	Vin	Power	3.25V to 5.5V
23-24	NC	-	Reserved for Factory Use
25	TTL_RX	Input	UART receiver
26	TTL_RX	Input	UART receiver
27	TTL_TX	Output	UART transmitter
28	TTL_TX	Output	UART transmitter
29	SYNC_IN	Input	TTL sync input to external rising edge signal
30	SYNC_IN	Input	TTL sync input to external rising edge signal
31	GND	Ground	Ground
32	Vin	Power	3.25V to 5.5V
33	NC	-	Reserved for Factory Use
34	NC	-	Reserved for Factory Use
35	DRDY	Output	Data Ready
36	DRDY	Output	Data Ready
37	SPI_CS	Input	SPI Chip Select (active-low)
38	SPI_CS	Input	SPI Chip Select (active-low)
39-40	GND	Ground	Ground

Note: It is recommended to connect identical signals across connector for redundancy.

Mounting Recommendations

The NavChip is designed to allow an end user the ability to integrate the device directly into their circuit card. Two high performance interface connectors allow users to easily install the NavChip while ensuring excellent performance from the device.

Please follow these layout guidelines for optimal performance in your application:

1. Refer to Figure 2: NavChip Mechanical Dimensions for clearances required for proper mounting.
2. It is recommended that no components are placed under the NavChip
3. Separation and alignment of the connector footprint is critical. Variance from the specified 8mm separation will induce un-calibrated stresses into the NavChip and may effect performance
4. Connectors are high retention strength so please use care when separating the NavChip from the mating connectors. It is important to subject both ends of the device to equal force when removing it.
5. Only handle the NavChip in an ESD controlled environment. Proper ESD guidelines (i.e. a grounded strap) should be used when handling the device.

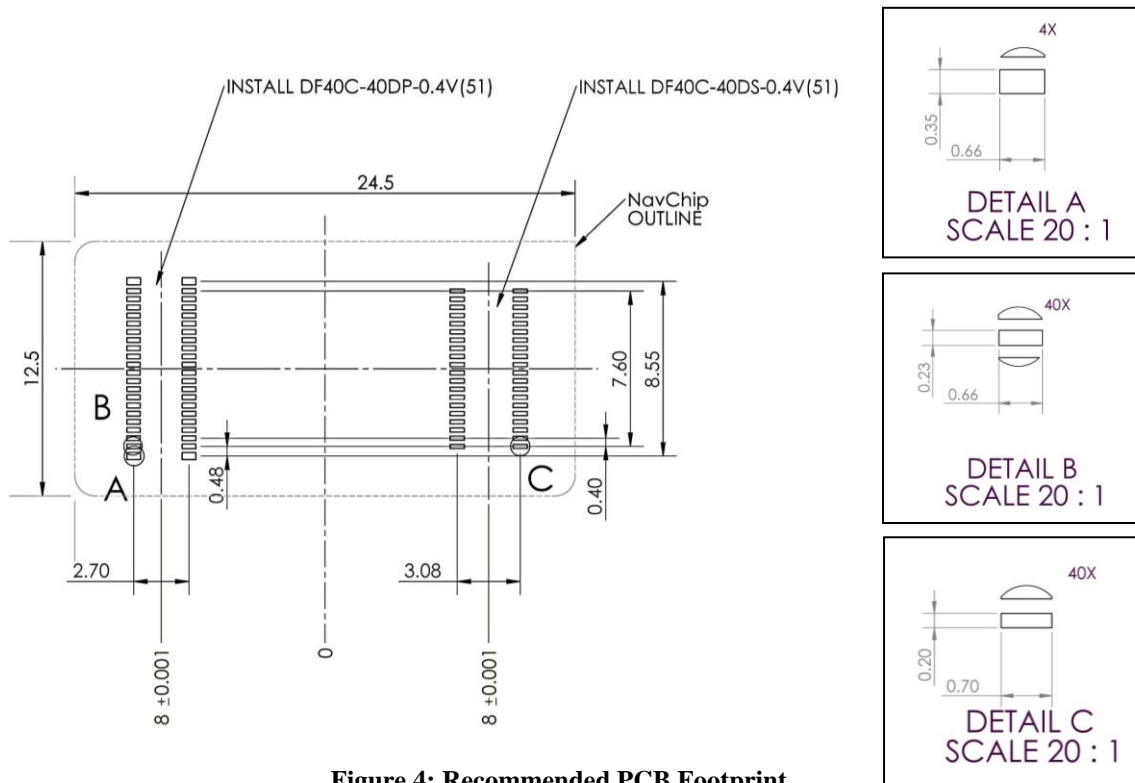


Figure 4: Recommended PCB Footprint

Ordering Information

Please reference to the following part numbers when ordering your desired NavChip configuration.

NAVCHIP	PART NUMBER
NavChip, Class A	V15206-17-02
NavChip, Class B	V15206-17-01

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